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May 2015

QEE113 Plastic Infrared Light Emitting Diode

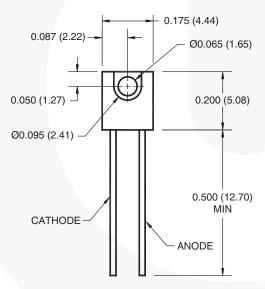
Features

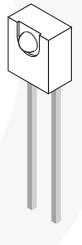
- $\lambda = 940 \text{ nm}$
- Package Type = Sidelooker
- Chip Material = GaAs
- Matched Photosensor: QSE113
- Medium Wide Emission Angle, 50°
- · Package Material: Clear Epoxy
- · High Output Power
- · Gray dot marking on the top side

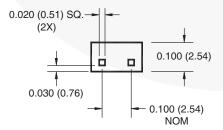
Description

The QEE113 is a 940 nm GaAs LED encapsulated in a medium wide angle, plastic sidelooker package.

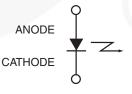
Package Dimensions(1, 2)







Schematic



Notes:

- 1. Dimensions for all drawings are in inches (mm).
- 2. Tolerance of ±0.010 (0.25) on all non-nominal dimensions unless otherwise specified.

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Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25^{\circ}\text{C}$ unless otherwise noted.

Symbol	Parameter	Value	Unit
T _{OPR}	Operating Temperature	-40 to +100	°C
T _{STG}	Storage Temperature	-40 to +100	°C
T _{SOL-I}	Soldering Temperature (Iron) ^(4, 5, 6)	240 for 5 sec	°C
T _{SOL-F}	Soldering Temperature (Flow) ^(4, 5)	260 for 10 sec	°C
I _F	Continuous Forward Current	50	mA
V _R	Reverse Voltage	5	V
P _D	Power Dissipation ⁽³⁾	100	mW

Notes:

- 3. Derate power dissipation linearly 1.33 mW/°C above 25°C.
- 4. RMA flux is recommended.
- 5. Methanol or isopropyl alcohols are recommended as cleaning agents.
- 6. Soldering iron 1/16" (1.6mm) minimum from housing.

Electrical / Optical Characteristics

Values are at $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
λ _{PE}	Peak Emission Wavelength	I _F = 20 mA		945		nm
TC_λ	Temperature Coefficient			0.3		nm/°C
2Θ ¹ /2	Emission Angle	I _F = 100 mA		50		0
V_{F}	Forward Voltage	$I_F = 100 \text{ mA}, \text{ tp} = 20 \text{ ms}$			1.5	V
TC_{VF}	Temperature Coefficient			-2		mV/°C
I _R	Reverse Current	V _R = 5 V		-/	10	μΑ
IE	Radiant Intensity	$I_F = 100 \text{ mA}, \text{ tp} = 20 \text{ ms}$	3	7.5	12	mW/sr
TC _{IE}	Temperature Coefficient			-0.7	,	%/°C
t _r	Rise Time	I _F = 100 mA		800		ns
t _f	Fall Time	IF = 100 IIIA		800		ns
C _j	Junction Capacitance	V _R = 0 V		14	19/4	pF

Typical Performance Characteristics

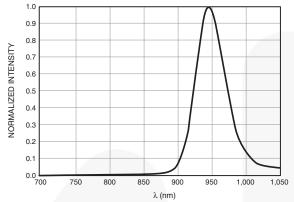


Figure 1. Normalized Intensity vs. Wavelength

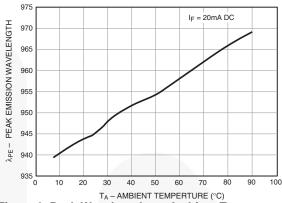


Figure 2. Peak Wavelength vs. Ambient Temperature

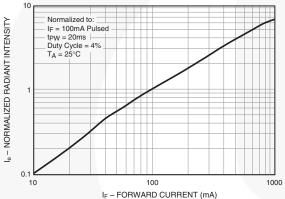


Figure 3. Normalized Radiant Intensity vs. Forward Current

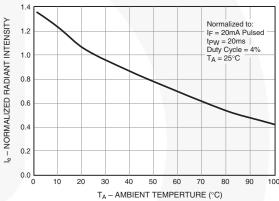


Figure 4. Normalized Radiant intensity vs.
Ambient Temperature

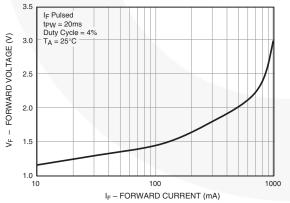


Figure 5. Forward Voltage vs. Forward Current

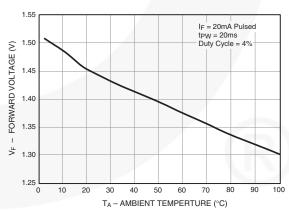


Figure 6. Forward Voltage vs. Ambient Temperature

Typical Performance Characteristics (Continued)

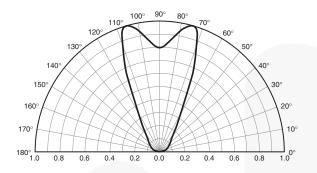
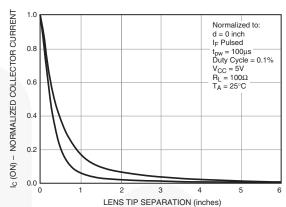


Figure 7. Radiation Diagram



LENS TIP SEPARATION (inches)
Figure 8. Coupling Characteristics
of QEE113 and QSE113





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Definition of Terms						
Datasheet Identification	Product Status	Definition				
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